



SGM4157YC

SPDT 0.8Ω Analog Switch

GENERAL DESCRIPTION

The SGM4157YC is a single low on-resistance (0.8Ω), fast single-pole double-throw (SPDT) CMOS switch. It is designed for low operating voltage, high current switching of speaker output for cell phone applications. The SGM4157YC can handle a balanced microphone/speaker/ring tone generator in a monophone mode. The device contains a break-before-make (BBM) feature.

The control input, IN, tolerates input drive signals up to 5.5V, independent of supply voltage.

SGM4157YC is available in SC70-6 package.

APPLICATIONS

Portable Instrumentation
Battery-Operated Equipment
Computer Peripherals
Cell Phones
PDAs
MP3s

FUNCTION TABLE

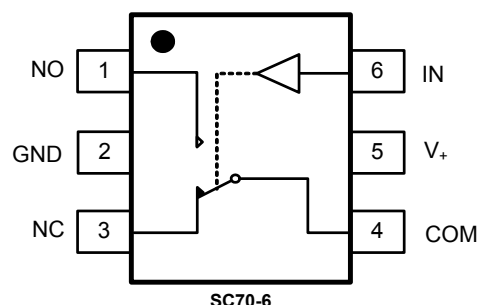
LOGIC	NO	NC
0	OFF	ON
1	ON	OFF

Switches Shown For Logic "0" Input

FEATURES

- **Voltage Operation: 1.8V to 5.5V**
- **On-Resistance: 0.8Ω (TYP)**
- **-3dB Bandwidth: 90MHz**
- **High Off-Isolation: -45dB at 10MHz**
- **Rail-to-Rail Operation**
- **Low Static Power**
- **TTL/CMOS Compatible**
- **Break-Before-Make Switching**
- **Extended Industrial Temperature Range: -40°C to +85°C**
- **Microsize Package**

PIN CONFIGURATION (TOP VIEW)



PIN DESCRIPTION

NAME	PIN	FUNCTION
NO	1	Normally-open terminal
GND	2	Ground
NC	3	Normally-closed terminal
COM	4	Common terminal
V ₊	5	Power supply
IN	6	Digital control pin to connect the COM terminal to the NO or NC terminals

NOTE: NO, NC and COM terminal may be an input or output.



SG Micro Limited
www.sg-micro.com

PACKAGE/ORDERING INFORMATION

MODEL	PIN-PACKAGE	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKAGE OPTION
SGM4157YC	SC70-6	-40°C to +85°C	SGM4157YC6/TR	S4BXX	Tape and Reel, 3000

NOTE: SC70-6 package is same as SOT-363 package.

MARKING INFORMATION

SYY X X

— Date code - Month ("A" = Jan. "B" = Feb. ... "L" = Dec.)

— Date code - Year ("9" = 2009, "A" = 2010 ...)

— Chip I.D.

For example: S4B9A (2009, January)

ABSOLUTE MAXIMUM RATINGS

V₊, IN to GND..... -0.3V to 6V
 Voltage Range of NC, NO, and COM Pins ⁽¹⁾
 -0.5V to (V₊) + 0.5V
 Continuous Current NO, NC, or COM..... ± 200mA
 Peak Current NO, NC, or COM..... ± 350mA
 Operating Temperature Range..... -40°C to +85°C

Junction Temperature..... 150°C
 Storage Temperature..... -65°C to +150°C
 Lead Temperature (soldering, 10s)..... 260°C
 ESD Susceptibility
 HBM..... 8000V
 MM..... 400V

NOTE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

(1) Signals on NC, NO, or COM or IN exceeding V₊ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

SGMICRO reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact SGMICRO sales office to get the last datasheet.

ELECTRICAL CHARACTERISTICS(V₊ = 4.5V to 5.5V, GND = 0V, Typical values are at T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
ANALOG SWITCH							
Analog Signal Range	V _{NO} , V _{NC} , V _{COM}		+25°C	0		V ₊	V
On-Resistance	R _{ON}	V ₊ = 4.5V, V _{NO} or V _{NC} = V ₊ /2, I _{COM} = -100mA, Test Circuit 1	+25°C		0.8		Ω
On-Resistance Match Between Channels	ΔR _{ON}	V ₊ = 4.5V, 0V ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -100mA, Test Circuit 1	+25°C		0.02		Ω
On-Resistance Flatness	R _{FLAT(ON)}	V ₊ = 4.5V, 0V ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -100mA, Test Circuit 1	+25°C		0.25		Ω
Source OFF Leakage Current	I _{NC(OFF)} , I _{NO(OFF)}	V ₊ = 5.5 V, V _{NO} or V _{NC} = 4.5V / 1V, V _{COM} = 1V / 4.5V	+25°C		0.1		μA
Channel ON Leakage Current	I _{NC(ON)} , I _{NO(ON)} , I _{COM(ON)}	V ₊ = 5.5V, V _{COM} = 1V / 4.5V, V _{NO} or V _{NC} = floating	+25°C		0.1		μA
DIGITAL INPUTS							
Input High Voltage	V _{INH}	V ₊ = 4.5V	+25°C	1.6			V
Input Low Voltage	V _{INL}	V ₊ = 4.5V	+25°C			0.6	V
Input Leakage Current	I _{IN}	V ₊ = 4.5V, V _{IN} = 0V or V ₊	+25°C		0.1		μA
DYNAMIC CHARACTERISTICS							
Turn-On Time ⁽¹⁾	t _{ON}	V ₊ = 4.5V, V _{NO} or V _{NC} = 3.0V, R _L = 300Ω, C _L = 35pF, Test Circuit 2	+25°C		56	90	ns
Turn-Off Time ⁽¹⁾	t _{OFF}	V ₊ = 4.5V, V _{NO} or V _{NC} = 3.0V, R _L = 300Ω, C _L = 35pF, Test Circuit 2	+25°C		32	55	ns
Break-Before-Make Time Delay	t _D	V ₊ = 4.5V, V _{NO} or V _{NC} = 3.0V, R _L = 300Ω, C _L = 35pF, Test Circuit 3	+25°C		28		ns
Skew	t _{SKEW}	R _S = 39Ω, C _L = 50pF, Test Circuit 4	+25°C		7		ns
Off Isolation	O _{ISO}	V ₊ = 4.5V, R _L = 50Ω, Signal = 0dBm, Test Circuit 5	10MHz	+25°C	-45		dB
			1MHz	+25°C	-65		dB
-3dB Bandwidth	BW	V ₊ = 4.5V, Signal = 0dBm, R _L = 50Ω, Test Circuit 6	+25°C		90		MHz
Channel ON Capacitance	C _{NC(ON)} , C _{NO(ON)} , C _{COM(ON)}	V ₊ = 4.5V, f = 1MHz	+25°C		40		pF
Channel OFF Capacitance	C _{NC(OFF)} , C _{NO(OFF)} , C _{COM(OFF)}	V ₊ = 4.5V, f = 1MHz	+25°C		8.5		pF
POWER REQUIREMENTS							
Power Supply Range	V ₊		+25°C	1.8		5.5	V
Power Supply Current	I ₊	V ₊ = 5.5V, V _{IN} = 0V or V ₊	+25°C		0.1		μA

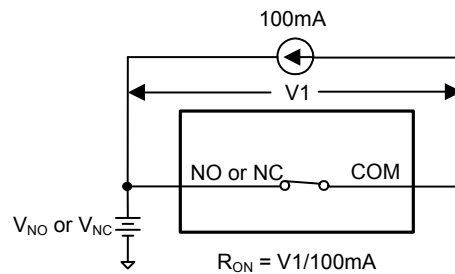
NOTE1: Maximum value is guaranteed by design.

ELECTRICAL CHARACTERISTICS(V₊ = 2.7V to 3.6V, GND = 0V, Typical values are at T_A = +25°C, unless otherwise noted.)

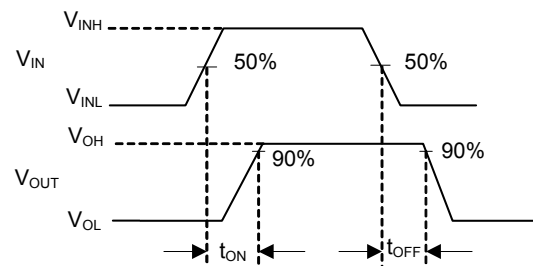
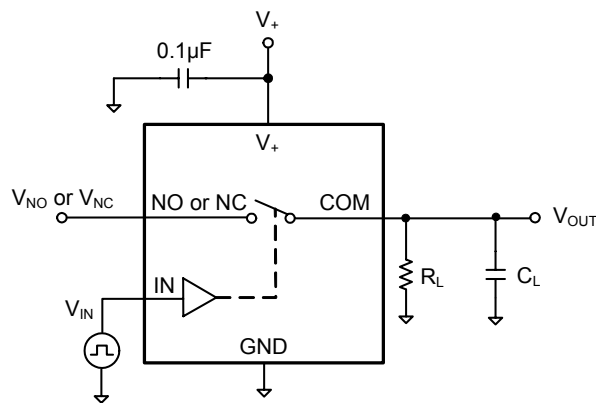
PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
ANALOG SWITCH							
Analog Signal Range	V _{NO} , V _{NC} , V _{COM}		+25°C	0		V ₊	V
On-Resistance	R _{ON}	V ₊ = 2.7V, V _{NO} or V _{NC} = V ₊ /2, I _{COM} = -100mA, Test Circuit 1	+25°C		1.4		Ω
On-Resistance Match Between Channels	ΔR _{ON}	V ₊ = 2.7V, 0V ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -100mA, Test Circuit 1	+25°C		0.03		Ω
On-Resistance Flatness	R _{FLAT(ON)}	V ₊ = 2.7V, 0V ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -100mA, Test Circuit 1	+25°C		0.9		Ω
Source OFF Leakage Current	I _{NC(OFF)} , I _{NO(OFF)}	V ₊ = 3.6 V, V _{NO} or V _{NC} = 3.3V / 0.3V, V _{COM} = 0.3V / 3.3V	+25°C		0.1		μA
Channel ON Leakage Current	I _{NC(ON)} , I _{NO(ON)} , I _{COM(ON)}	V ₊ = 3.6V, V _{COM} = 0.3V / 3.3V, V _{NO} or V _{NC} = floating	+25°C		0.1		μA
DIGITAL INPUTS							
Input High Voltage	V _{INH}	V ₊ = 2.7V	+25°C	1.4			V
Input Low Voltage	V _{INL}	V ₊ = 2.7V	+25°C			0.4	V
Input Leakage Current	I _{IN}	V ₊ = 2.7V, V _{IN} = 0V or V ₊	+25°C		0.1		μA
DYNAMIC CHARACTERISTICS							
Turn-On Time ⁽¹⁾	t _{ON}	V ₊ = 3V, V _{NO} or V _{NC} = 1.5V, R _L = 300Ω, C _L = 35pF, Test Circuit 2	+25°C		88	115	ns
Turn-Off Time ⁽¹⁾	t _{OFF}	V ₊ = 3V, V _{NO} or V _{NC} = 1.5V, R _L = 300Ω, C _L = 35pF, Test Circuit 2	+25°C		46	70	ns
Break-Before-Make Time Delay	t _D	V ₊ = 3V, V _{NO} or V _{NC} = 1.5V, R _L = 300Ω, C _L = 35pF, Test Circuit 3	+25°C		43		ns
Skew	t _{SKEW}	R _S = 39Ω, C _L = 50pF, Test Circuit 4	+25°C		7		ns
Off Isolation	O _{ISO}	V ₊ = 3V, R _L = 50Ω, Signal = 0dBm, Test Circuit 5	+25°C		-45		dB
		10MHz	+25°C		-65		dB
-3dB Bandwidth	BW	V ₊ = 3V, Signal = 0dBm, R _L = 50Ω, Test Circuit 6	+25°C		90		MHz
Channel ON Capacitance	C _{NC(ON)} , C _{NO(ON)} , C _{COM(ON)}	V ₊ = 3V, f = 1MHz	+25°C		40		pF
Channel OFF Capacitance	C _{NC(OFF)} , C _{NO(OFF)} , C _{COM(OFF)}	V ₊ = 3V, f = 1MHz	+25°C		8.5		pF
POWER REQUIREMENTS							
Power Supply Current	I ₊	V ₊ = 3.6V, V _{IN} = 0V or V ₊	+25°C		0.1		μA

NOTE1: Maximum value is guaranteed by design.

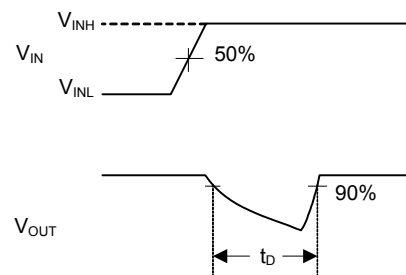
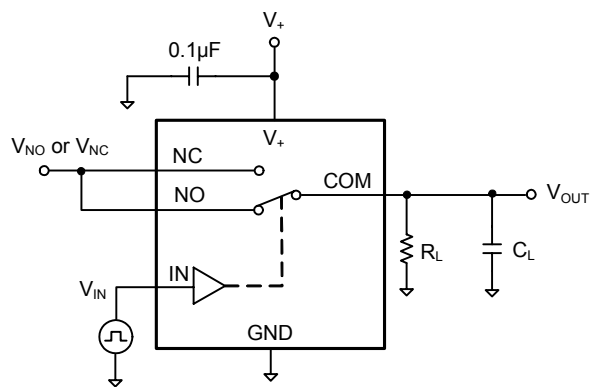
TEST CIRCUITS



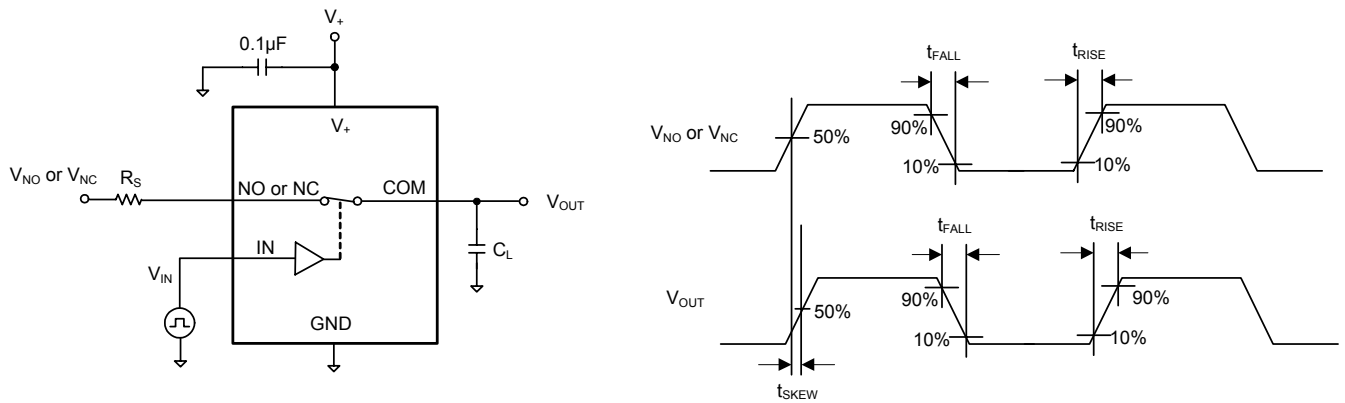
Test Circuit 1. On Resistance



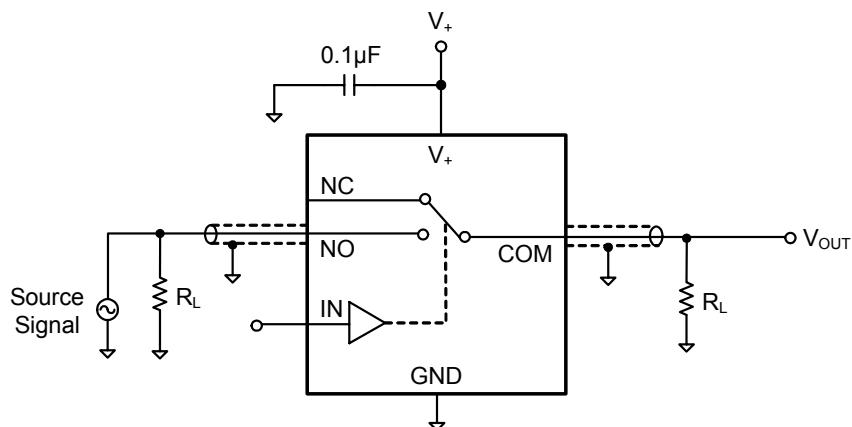
Test Circuit 2. Switching Times

Test Circuit 3. Break-Before-Make Time Delay, t_D

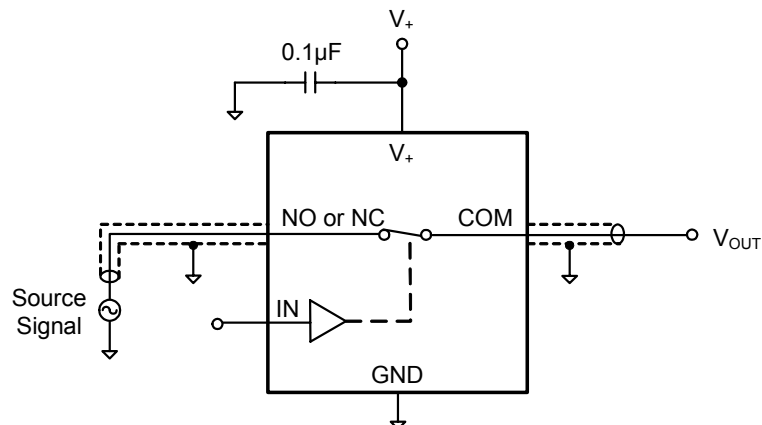
TEST CIRCUITS (Cont.)



Test Circuit 4. Skew Test



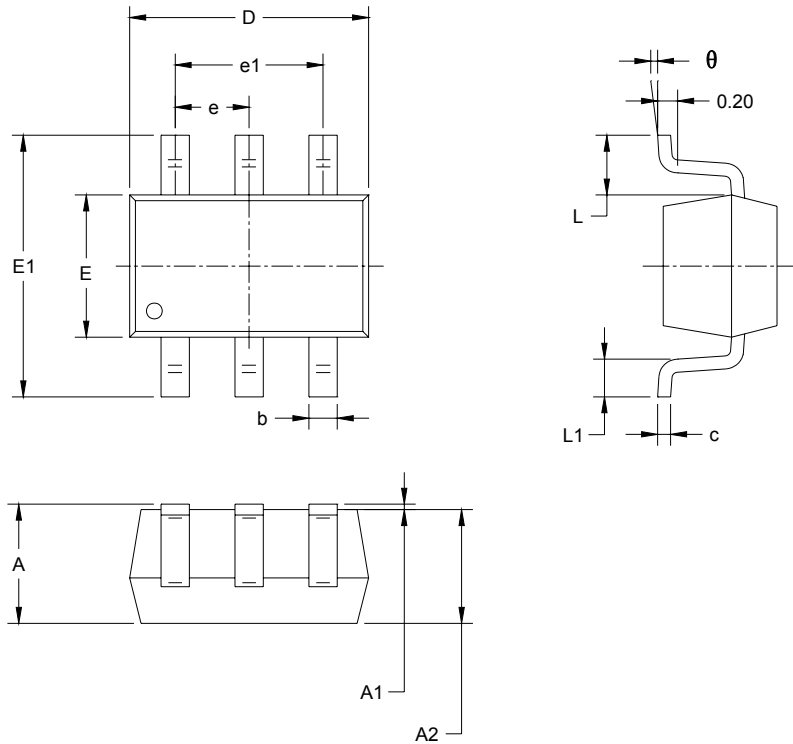
Test Circuit 5. Off Isolation



Test Circuit 6. -3dB Bandwidth

PACKAGE OUTLINE DIMENSIONS

SC70-6 / SOT-363



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.65 TYP		0.026 TYP	
e1	1.300 BSC		0.051 BSC	
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°